

UTC UNISONIC TECHNOLOGIES CO., LTD

7N50 **Preliminary Power MOSFET**

7A, 500V N-CHANNEL POWER MOSFET

DESCRIPTION

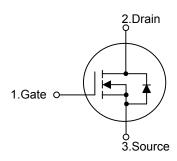
The UTC 7N50 is an N-channel mode power MOSFET using UTC's advanced technology to provide customers with planar stripe and DMOS technology. This technology allows a minimum on-state resistance and superior switching performance. It also can withstand high energy pulse in the avalanche and commutation mode.

The UTC 7N50 is generally applied in high efficiency switch mode power supplies, active power factor correction and electronic lamp ballasts based on half bridge topology.

FEATURES

- * $R_{DS(ON)}$ =1.0 Ω @ V_{GS} =10V
- * High Switching Speed
- * 100% Avalanche Tested

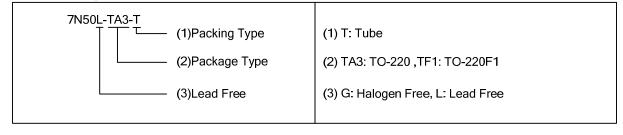
SYMBOL

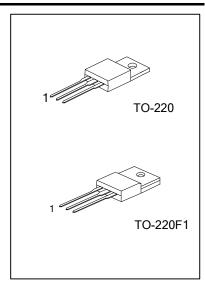


ORDERING INFORMATION

Ordering Number		Doolsono	Pin	Dealine			
Lead Free	Halogen Free	Package	1	2	3	Packing	
7N50L-TA3-T	7N50G-TA3-T	TO-220	G	D	S	Tube	
7N50L-TF1-T	7N50G-TF1-T	TO-220F1	G	D	S	Tube	

Note: Pin Assignment: G: Gate D: Drain S: Source





■ ABSOLUTE MAXIMUM RATINGS (T_C=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		V_{DSS}	500	V	
Gate-Source Voltage		V_{GSS}	±30	V	
Drain Current	Continuous (T _C =25°C)	I_{D}	7 (Note 5)	Α	
	Pulsed (Note 2)	I_{DM}	28 (Note 5)	Α	
Avalanche Current (Note 2)		I_{AR}	7	Α	
Avalanche Energy	Single Pulsed (Note 3)	E _{AS}	270	mJ	
	Repetitive (Note 4)	E_{AR}	8.9	mJ	
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.5	V/ns	
TO-220			89	W	
Power Dissipation (T _C =2	TO-220F1	_ [39	VV	
TO-220		P_D	0.71	VA//9.C	
Derate above 25°C	TO-220F1		0.31	W/°C	
Junction Temperature		TJ	+150	°C	
Storage Temperature		T_{STG}	-55~+150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature
- 3. L = 10mH, I_{AS} = 7A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25 $^{\circ}$ C
- 4. $I_{SD} \le 7A$, $di/dt \le 200A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$
- 5. Drain current limited by maximum junction temperature

■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT	
Junction to Ambient		θ_{JA}	62.5	°C/W	
Junction to Case	TO-220	0	1.4	°C/\\	
	TO-220F1	θ _{JC}	3.2	°C/W	

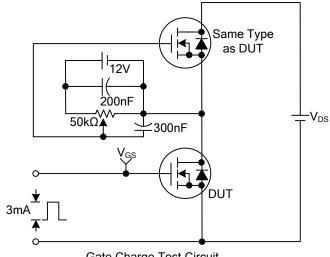
■ ELECTRICAL CHARACTERISTICS (T_C=25°C, unless otherwise noted)

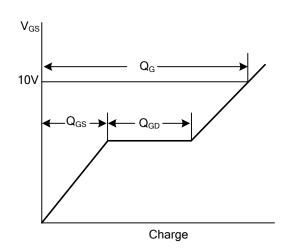
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS			•	•	•		
Drain-Source Breakdown Voltage		BV _{DSS}	I _D =250μA, V _{GS} =0V	500			V
Drain-Source Leakage Current		I _{DSS}	V _{DS} =500V, V _{GS} =0V			1	
			V _{DS} =400V, T _C =125°C			10	μΑ
Gate- Source Leakage Current	Forward	I _{GSS}	V _{GS} =+30V, V _{DS} =0V			+100	nA
	Reverse		V _{GS} =-30V, V _{DS} =0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS}=V_{GS}, I_{D}=250\mu A$ 3.0			5.0	V
Static Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} =10V, I _D =3.5A		8.0	1.0	Ω
DYNAMIC PARAMETERS							
Input Capacitance		C _{ISS}			720	940	pF
Output Capacitance		Coss	V _{GS} =0V, V _{DS} =25V, f=1.0MHz		95	190	pF
Reverse Transfer Capacitance		C_{RSS}			9	13.5	pF
SWITCHING PARAMETERS							
Total Gate Charge		Q_G	V _{GS} =10V, V _{DS} =400V, I _D =7A		12.8	16.6	nC
Gate to Source Charge		Q_GS	(Note 1, 2)		3.7		nC
Gate to Drain Charge		Q_GD			5.8		nC
Turn-ON Delay Time		t _{D(ON)}			6	20	ns
Rise Time		t _R	V _{DD} =250V, I _D =7A, R _G =25Ω (Note 1, 2)		55	120	ns
Turn-OFF Delay Time		t _{D(OFF)}			25	60	ns
Fall-Time		t _F			35	80	ns
SOURCE- DRAIN DIODE RATIN	NGS AND (CHARACTERI	STICS				
Maximum Body-Diode Continuous Current		Is				7	Α
Maximum Body-Diode Pulsed Current		I _{SM}				28	Α
Drain-Source Diode Forward Voltage		V_{SD}	I _S =7A, V _{GS} =0V			1.4	V
Body Diode Reverse Recovery Time		t _{rr}	I _S =7A, V _{GS} =0V,		275		ns
Body Diode Reverse Recovery Charge		Q_RR	dI _F /dt=100A/µs (Note 1)		0.04		μC

Notes: 1. Pulse Test: Pulse width $\leq 300\mu s$, Duty cycle $\leq 2\%$

^{2.} Essentially independent of operating temperature

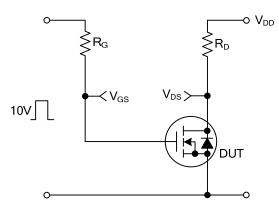
TEST CIRCUITS AND WAVEFORMS

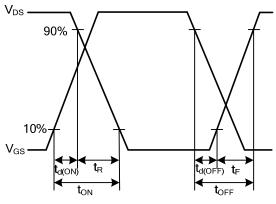




Gate Charge Test Circuit

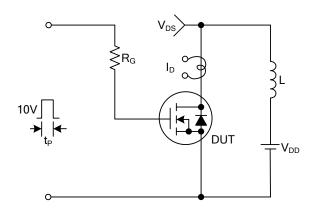
Gate Charge Waveforms

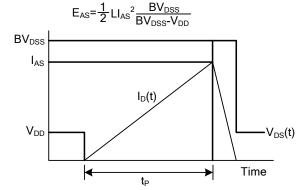




Resistive Switching Test Circuit



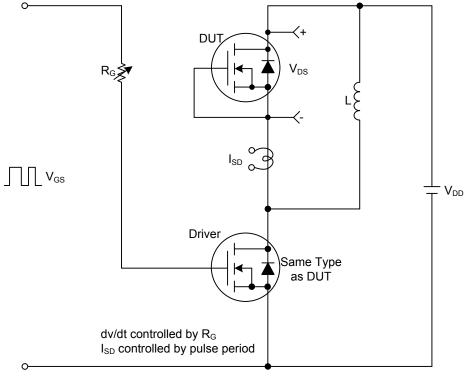




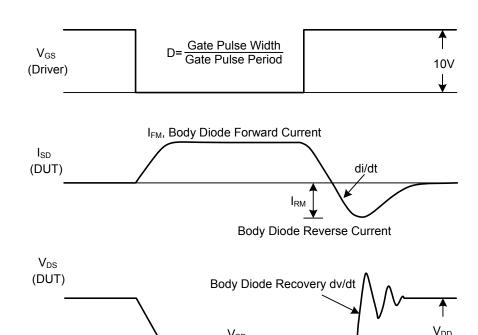
Unclamped Inductive Switching Test Circuit

Unclamped Inductive Switching Waveforms

■ TEST CIRCUITS AND WAVEFORMS(Cont.)



Peak Diode Recovery dv/dt Test Circuit & Waveforms



Body Diode Forward Voltage Drop

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